



MSB12M

1.2A SURFACE MOUNT GLASS PASSIVATED BRIDGE RECTIFIER

Product Summary (@TA = +25°C)

V _{RRM} (V)	I _O (A)	V _F (V)	I _R (μA)
1,000	1.2	1.1	5

Features and Benefits

- Glass Passivated Die Construction
- Compact, Thin Profile Package Design
- Reliable Robust Construction
- Ideal for SMT Manufacturing
- Lead Free Finish; RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)

Description and Applications

Suitable for AC to DC bridge full-wave rectification for SMPS; LED lighting, adapters, battery chargers, home appliances, office equipment, and telecommunications applications.

Mechanical Data

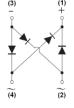
- Case: MSB
- Case Material: Molded Plastic; UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish Matte Tin Annealed over Copper Leadframe;
 Solderable per MIL-STD-202, Method 208 (@3)
- Polarity: As Marked on Body
- Weight: 0.09 grams (Approximate)

MSB



Top View





Internal Schematic

Ordering Information (Note 4)

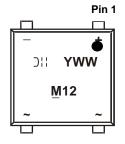
Part Number	Case	Packaging
MSB12M-13	MSB	3,000/Tape & Reel

Notes:

- 1. EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant. All applicable RoHS exemptions applied.
- See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at http://www.diodes.com/products/packages.html.

Marking Information

MSB



MXX = Product Type Marking Code,
(XX = 12)

II = Manufacturers' Code Marking
YWW = Date Code Marking
Y = Last Digit of Year (ex: 6 = 2016)
WW = Week Code (01 ~ 53)



Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Single phase, half wave, 60Hz, resistive or inductive load. For capacitance load, derate current by 20%.

Characteristic		Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage		V _{RRM} V _{RWM} V _R	1,000	٧
RMS Reverse Voltage		V _{R(RMS)}	700	V
Average Rectified Output Current	@T _C = +120°C	lo	1.2	Α
Non-Repetitive Peak Forward Surge Current, 8.3ms Single Half Sine-Wave Superimposed on Rated Load		I _{FSM}	45	Α

Thermal Characteristics

Characteristic	Symbol	Value	Unit
Typical Thermal Resistance, Junction to Ambient (Note 5)	R _{θJA}	70	°C/W
Typical Thermal Resistance, Junction to Case	R _{θJC}	10	°C/W
Typical Thermal Resistance, Junction to Lead	R _{0JL}	30	°C/W
Operating and Storage Temperature Range	$T_{J,}T_{STG}$	-55 to +150	°C

Electrical Characteristics (@ $T_A = +25^{\circ}C$, unless otherwise specified.)

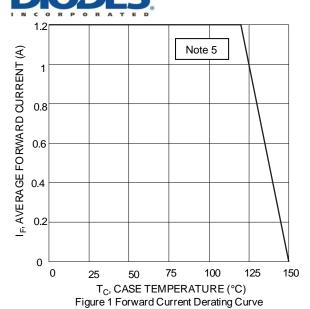
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
Reverse Breakdown Voltage (Note 6)	$V_{(BR)R}$	1,000	-		٧	$I_R = 5\mu A$
Forward Voltage	V _F	_	0.9	1.1		I _F = 0.6A
Torward Voltage	٧F	1	1.0	1.2		I _F = 1.2A
Leakage Current (Note 6)	I _R	_	_	5	μΑ	$V_R = 1,000V, T_A = +25$ °C $V_R = 1,000V, T_A = +125$ °C
Leakage Current (Note o)		1	1	500		$V_R = 1,000V, T_A = +125$ °C
Typical Total Capacitance	C _T	1	30	1	pF	$V_R = 4V$, $f = 1.0MHz$

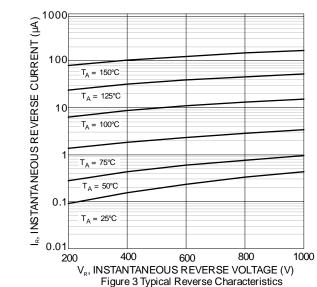
Notes:

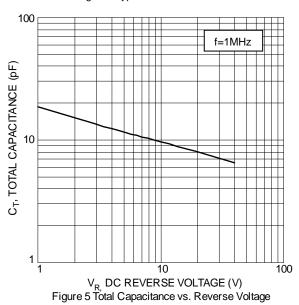
^{5.} Device mounted on glass-epoxy substrate with 1 oz 20mm x 20mm Cu pad per pin.

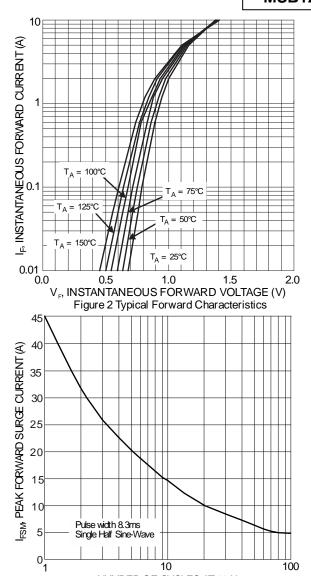
^{6.} Short duration pulse test used to minimize self-heating effect.









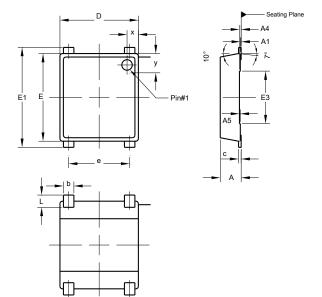


NUMBER OF CYCLES AT 60 H $_{\rm Z}$ Figure 4 Forward Surge Current Derating Curve



Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

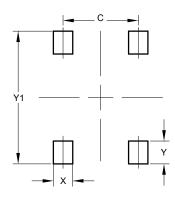


MSB					
Dim	Min	Max	Тур		
Α	1.10	1.30	1.20		
A1	0.00	0.05	0.02		
A4	0.05	0.08	-		
A5	0.03	0.08	0.05		
b	0.55	0.70	0.60		
С	0.12	0.18	0.15		
D	4.40	4.60	4.50		
E	4.90	5.10	5.00		
E1	5.60	5.80	5.70		
E3	2.95	3.05	3.00		
е	3.45	3.55	3.50		
L	0.65	0.75	0.70		
X	0.60	0.70	0.65		
у	0.60	0.70	0.65		
All Dimensions in mm					

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

MSB



Dimensions	Value (in mm)		
С	3.55		
Х	0.90		
Y	1.05		
Y1	6.10		



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